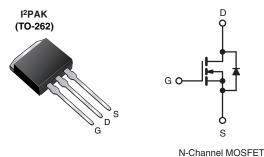


**Vishay Siliconix** 

COMPLIANT

#### **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	500				
R <sub>DS(on)</sub> (Ω)	$V_{GS} = 10 V$	0.55			
Q <sub>g</sub> (Max.) (nC)	51				
Q <sub>gs</sub> (nC)	12				
Q <sub>gd</sub> (nC)	23				
Configuration	Single				



#### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

ORDERING INFORMATION	
Package	I <sup>2</sup> PAK (TO-262)
Lood (Db) froo	IRFSL11N50APbF
Lead (Pb)-free	SiHFSL11N50A-E3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V <sub>DS</sub>	500	v			
Gate-Source Voltage	V <sub>GS</sub>	± 30	v			
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	I	11		
	VGS at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	7.0	А	
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	44	1			
Linear Derating Factor				1.3	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>		E <sub>AS</sub>	390	mJ		
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	11	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	19	mJ	
Maximum Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			PD	190	W	
Peak Diode Recovery dV/dtc		dV/dt	4.1	V/ns		
Operating Junction and Storage Temperature Range	е		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	- °C	
Soldering Recommendations (Peak Temperature) for 10 s				300 <sup>d</sup>		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

- b. Starting  $T_J = 25 \text{ °C}$ , L = 6.4 mH,  $R_G = 25 \Omega$ ,  $I_{AS} = 11 \text{ A}$  (see fig. 12). c.  $I_{SD} \le 11 \text{ A}$ , dl/dt  $\le 185 \text{ A/}\mu\text{s}$ ,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175 \text{ °C}$ .

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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PARAMETER	SYMBOL	TYP	<b>.</b>	MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	- 40					
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-		0.75		°C/W		
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u	nless otherw	vise noted)						
PARAMETER	SYMBOL	TES	ST CONDITIO	NS	MIN.	TYP.	MAX.	UNI
Static							1	<u> </u>
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub>	s = 0, I <sub>D</sub> = 250	μA	500	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I <sub>D</sub> = 1 mA		-	0.57	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 25	Ο μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 30 V		-	-	± 100	nA
		V <sub>DS</sub> =	= 500 V, V <sub>GS</sub> =	= 0 V	-	-	25	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 400 V	/, V <sub>GS</sub> = 0 V, 1	<sub>J</sub> = 150 °C	-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> =	6.6 A <sup>b</sup>	-	-	0.55	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	= 50 V, I <sub>D</sub> = 6.	6 A <sup>b</sup>	6.0	-	-	S
Dynamic								
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V		-	1426	-	
Output Capacitance	C <sub>oss</sub>	1	$V_{DS} = 25 V$		-	208	-	1
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	9.6	-		
	the Capacitance $C_{oss}$ $V_{GS} = 0 V$ $V_{DS} = 1.0 V, f = 1.0 MHz$ $V_{DS} = 400 V, f = 1.0 MHz$		V <sub>DS</sub> = 1.0 V	′, f = 1.0 MHz	-	1954	-	- pF
Output Capacitance		-	53	-				
Effective Output Capacitance	C <sub>oss</sub> eff.	-	V <sub>DS</sub> = 0 V to 400 V <sup>c</sup>		-	110	-	1
Total Gate Charge	Qg				-	-	51	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		$V_{DS} = 400 V$	-	-	12	nC
Gate-Drain Charge	Q <sub>gd</sub>	-	see lig.	6 and 13 <sup>b</sup>	-	-	23	
Turn-On Delay Time	t <sub>d(on)</sub>				-	14	-	
Rise Time	t <sub>r</sub>	- 	= 250 V, I <sub>D</sub> = <sup>-</sup>	11 Δ	-	34	-	-
Turn-Off Delay Time	t <sub>d(off)</sub>		$R_{\rm D} = 22 \ \Omega, \ s$		_	32	_	ns
Fall Time	t <sub>f</sub>	-			_	27	_	-
Internal Drain Inductance	L <sub>D</sub>	Between lead 6 mm (0.25")	,		-	4.5	-	
Internal Source Inductance	L <sub>S</sub>	package and die contact	center of		-	7.5	-	nH
Drain-Source Body Diode Characteristic	s	1					•	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	11		
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral revers p - n junction			-	-	44	A
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 11 A, V	<sub>GS</sub> = 0 V <sup>b</sup>	-	-	1.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 25 °C I	<sub>F</sub> = 11 A, dl/d <sup>.</sup>		-	530	790	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	J = 25  O, I	⊢ – TTA, ui/u	ι – του Αγμο <sup>ο</sup>	-	3.4	5.1	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	urn-on time is	negligible (turn	-on is doi	minated b	y L <sub>S</sub> and	L <sub>D</sub> )

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. Pulse width ≤ 300 µs; duty cycle ≤ 2 %.
c. C<sub>oss</sub> eff. is a fixed capacitance that gives the same charging time as C<sub>oss</sub> while V<sub>DS</sub> is rising from 0 % to 80% V<sub>DS</sub>.

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100

ID. Drain-to-Source Current (A)

10

1

TOP

VGS 15V 10V

8.01

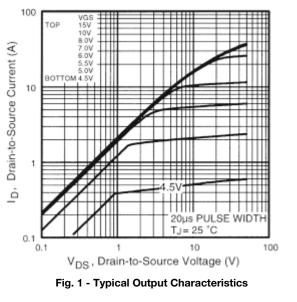
7.0%

6.0V 5.5V 0% IOTTOM 4.5V

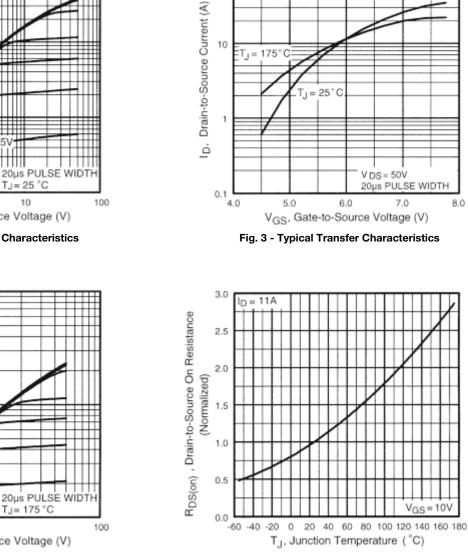
## IRFSL11N50A, SiHFSL11N50A

**Vishay Siliconix** 

8.0



#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



100

10

175

25 C

Fig. 2 - Typical Output Characteristics

10

V<sub>DS</sub>, Drain-to-Source Voltage (V)

TJ= 175 °C

5

Fig. 4 - Normalized On-Resistance vs. Temperature

### Vishay Siliconix

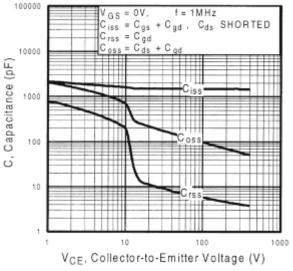


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

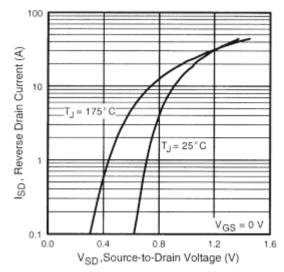


Fig. 7 - Typical Source-Drain Diode Forward Voltage

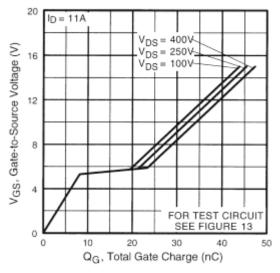


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

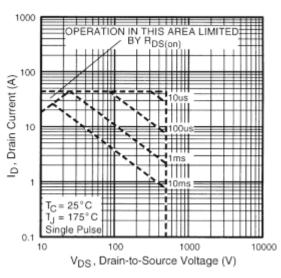


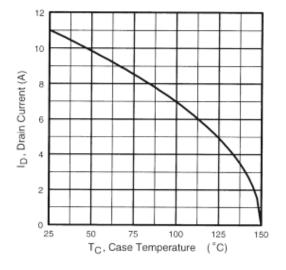
Fig. 8 - Maximum Safe Operating Area



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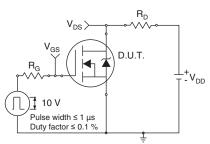


Fig. 10a - Switching Time Test Circuit

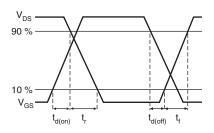
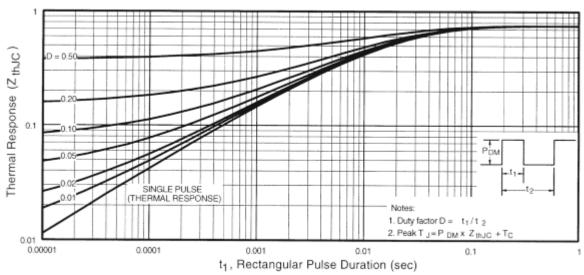
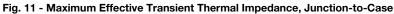
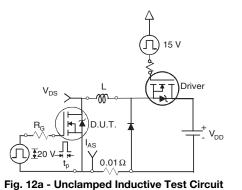


Fig. 10b - Switching Time Waveforms







DS  $I_{AS}$ 

Fig. 12b - Unclamped Inductive Waveforms

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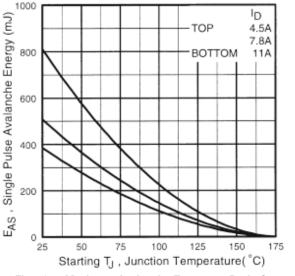
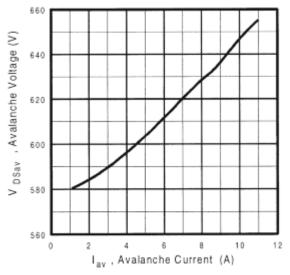
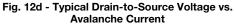


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





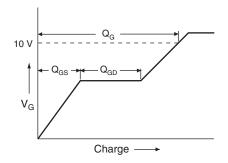


Fig. 13a - Basic Gate Charge Waveform

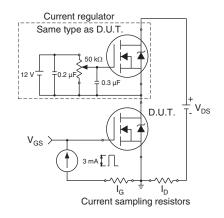


Fig. 13b - Gate Charge Test Circuit

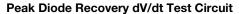
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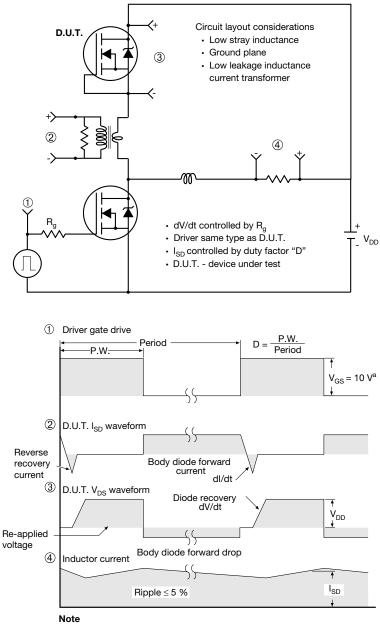
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a. V<sub>GS</sub> = 5 V for logic level devices

Fig. 11 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg291288">www.vishay.com/ppg291288</a>.

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix** 

Seating plane

#### **TO-263AB (HIGH VOLTAGE)**

/3 ⁄4 A

н

∕₅∖

Detail A

(Datum A)

D

 $\underline{4}$ 11

	2	-	▼ 2 x b2 2 x b ⊕ 0.010 @ A(	DB    ating    b1, b    b1, b    (c)    (c)    (c)    (c)    (c)    (c)    (c)    Section B - I    Scale:	$\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{7} \\$	<b>a</b> - 1		l l	1 4	
	MILLIN	IETERS	INC	HES			MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-
A 4	0.00	0.25	0.000	0.010		Е	9.65	10.67	0.380	0.420
A1	0.00	0.25								
b A1	0.51	0.25	0.020	0.039		E1	6.22	-	0.245	-
			0.020 0.020	0.039 0.035		E1 e		- BSC	0.245 0.100	BSC
b	0.51	0.99						- BSC 15.88		- BSC 0.625
b b1	0.51 0.51	0.99 0.89	0.020	0.035		е	2.54		0.100	
b b1 b2	0.51 0.51 1.14	0.99 0.89 1.78	0.020 0.045	0.035		e H	2.54 14.61	15.88	0.100 0.575	0.625
b b1 b2 b3	0.51 0.51 1.14 1.14	0.99 0.89 1.78 1.73	0.020 0.045 0.045	0.035 0.070 0.068		e H L	2.54 14.61 1.78	15.88 2.79	0.100 0.575 0.070	0.625 0.110
b b1 b2 b3 c	0.51 0.51 1.14 1.14 0.38	0.99 0.89 1.78 1.73 0.74	0.020 0.045 0.045 0.015	0.035 0.070 0.068 0.029		e H L L1	2.54 14.61 1.78 - -	15.88 2.79 1.65	0.100 0.575 0.070 -	0.625 0.110 0.066 0.070
b b1 b2 b3 c c1	0.51 0.51 1.14 1.14 0.38 0.38	0.99 0.89 1.78 1.73 0.74 0.58	0.020 0.045 0.045 0.015 0.015	0.035 0.070 0.068 0.029 0.023		e H L L1 L2	2.54 14.61 1.78 - -	15.88 2.79 1.65 1.78	0.100 0.575 0.070 - -	0.625 0.110 0.066 0.070

Α

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



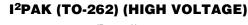
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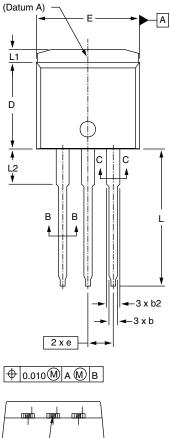
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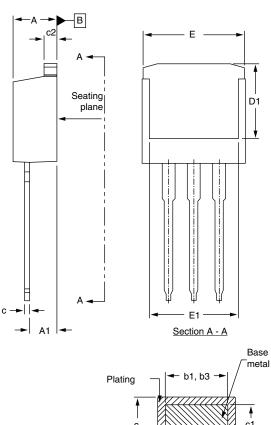


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				Г	Bas met
ting	<⊢ b	01, b3	3 →	/	
1					•
c 					c1 ∳
<u>.</u>		(b, b2	» —		
	 ,	(0, 02	-/ -		

Section B - B and C - C Scale: None

	MILLIN	IETERS	INC	HES			
DIM.	MIN.	MAX.	MIN.	MAX.			
А	4.06	4.83	0.160	0.190			
A1	2.03	3.02	0.080	0.119			
b	0.51	0.99	0.020	0.039			
b1	0.51	0.89	0.020	0.035			
b2	1.14	1.78	0.045	0.070			
b3	1.14	1.73	0.045	0.068			
с	0.38	0.74	0.015	0.029			
c1	0.38	0.58	0.015	0.023			
c2	1.14	1.65	0.045	0.065			
	ECN: S-82442-Rev. A, 27-Oct-08 DWG: 5977						

	MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D	8.38	9.65	0.330	0.380
D1	6.86	-	0.270	-
E	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	-
е	2.54	BSC	0.100 BSC	
L	13.46	14.10	0.530	0.555
L1	-	1.65	-	0.065
L2	3.56	3.71	0.140	0.146

#### Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outmost extremes of the plastic body.

3. Thermal pad contour optional within dimension E, L1, D1, and E1.

4. Dimension b1 and c1 apply to base metal only.



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